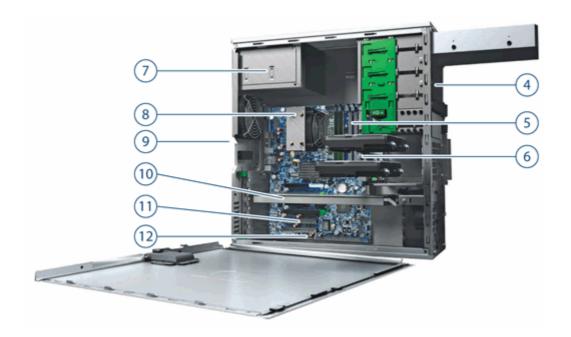


- 1. 3 External 5.25" Bays
- 2. Power Button
- 3. Front I/O: 2 USB 2.0, 1 IEEE 1394a, Headphone, Microphone



- 4. 3 External 5.25" Bays
- 4-DIMM slots/ 6-DIMM slots (depending on base unit model) for DDR3 ECC memory
- 6. 2 Internal 3.5" Bays
- 7. 475W, 85% efficient Power Supply
- 8. Dual/Quad/Six Core Intel 3500/3600 Series Processors
- Rear I/O: 6 USB 2.0, PS/2 keyboard/mouse
 RJ-45 to Integrated Gigabit LAN
 Audio Line In, 1 Audio Line Out, 1 Microphone In
- 10. 2 PCle x16 Gen2 Slots
- 11. 1 PCle x4 Gen2, 1 PCle x4 Gen1, 2 PCl Slots
- 12. 4 Internal USB 2.0 ports

Form Factor	Convertible Minitower
Operating Systems	Genuine Windows® 7 Ultimate 64-Bit*
	Genuine Windows® 7 Professional 32-Bit*
	Genuine Windows® 7 Professional 64-Bit*
	* Systems may require upgraded and/or separately purchased hardware and/or a DVD drive to install the
	Windows 7 software and take full advantage of Windows 7 functionality. See
	http://www.microsoft.com/windows/windows-7/ for details.
	HP Linux Installer Kit for Linux
	[includes drivers for 32-bit & 64-bit OS versions of
	Red Hat Enterprise Linux(RHEL) 4 Workstation,
	Red Hat Enterprise Linux (RHEL) 5 Workstation,
	Red Hat Enterprise Linux (RHEL) 6 Workstation,
	64-bit SUSE Linux Enterprise Desktop (SLED) 11]
	See http://www.hp.com/workstations/software/linux for details.
	SUSE Linux Enterprise Desktop 11 Linux preloaded
	Red Hat Enterprise Linux (as Drop-in-the-box paper license only)
	For detailed OS/hardware support information for Linux, see:
	http://www.hp.com/support/linux hardware matrix
Available Processors	Intel® Xeon® Processor W3503 2.40 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core Intel Xeon Processor W3505 2.53 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core Intel Xeon Processor W3520 2.66 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT,



Available Processor Disclaimers	Turbo Intel Xeon Processor W3550 3.06 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT, Turbo Intel Xeon Processor W3565 3.20 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT, Turbo Intel Xeon Processor W3670 3.20 GHz, 12MB cache, 1066 memory, 4.8 GT/s QPI, Six-Core, HT, Turbo Intel Xeon Processor W3680 3.33 GHz, 12MB cache, 1333 memory, 6.4 GT/s QPI, Six-Core, HT, Turbo Intel Xeon Processor W3690 3.46 GHz, 12MB cache, 1333 memory, 6.4 GT/s QPI, Six-Core, HT, Turbo Intel's numbering is not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details. 64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Dual-Core, Quad-Core and Six-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits. Check with software provider to determine suitability. Not all customers or software applications will necessarily benefit from use of these technologies.					
Chipset	echnologies. ntel® X58 Express					
Convertibility	Yes. 5.25" drives rotate for Minitower or Desktop orientation.					
Expansion Slots (see system board section for more details)	 2 PCI slots (full-height, full-length) 1 PCI Express Gen1 slot x8 mechanical/x4 electrical 1 PCI Express Gen2 slot x8 mechanical/x4 electrical 2 PCI Express Gen2 slots x16 (one dedicated for graphics) 					
	NOTE: The PCle x8 connectors are open ended, allowing a PCle x16 card to be seated in the slot.					
Expansion Bays (see storage section for more details)	 2 internal 3.5" bays 3 external 5.25" bays NOTE: Third external 5.25" bay is not full depth; maximum depth 170 mm (6.7 inches)					
Memory	PC3-10600 DDR3-1333 ECC Unbuffered DIMMs					
Front I/O	2 USB 2.0, 1 IEEE 1394a standard, 1 audio out, and 1 microphone.					
Internal I/O	4 USB 2.0 ports available by two separate 2x5 headers: supports either up to two HP Internal USB Port Kits, AMO- EM165AA (one port on each Kit), or up to two USB Media Card Readers, or one Internal Port kit and one USB Media Card Reader.					
Rear I/O	6 USB 2.0, 2 USB 3.0 (requires optional PCle card), 1 optional serial port, 2 optional IEEE 1394a or 1394b ports (requires PCl card), 2 PS/2, RJ-45 (NIC), 1 audio line in, 1 audio line out, 1 microphone in; audio ports can be retasked to function as line in, line out, microphone, or headphone.					
Interfaces Supported	22-in-1 Media Card Reader (optional)					
Chassis Dimensions (HxWxD)	Standard minitower orientation: 45.02 x 16.79 x 45.53 cm (17.7 x 6.6 x 17.9 in) Converted desktop orientation: 45.02 x 16.79 x 45.53 cm (17.7 x 6.6 x 17.9 in)					
Weight	Exact weights depend upon configuration Minimum: 13.5 kg (29.8 lbs) Standard: 15.1 kg (33.2 lbs) Maximum: 19.6 kg (43.2 lbs)					
Temperature	Operating: 5° to 35°C (40° to 95°F) Non-operating -40° to 60°C (-40° to 140°F)					



Humidity	Operating:	8% to 85%				
	Non-operating	8% to 90%				
Maximum Altitude (non-	Operating:	3,000 m; 10,000 feet				
pressurized)	Non-operating	9,100 m; 30,000 feet				
Power Supply		e Power Factor Correction, 85% Efficient				
		ne Z400 475W power supply efficiency report can be found at this link:				
	http://www.plugloadsolutions	ww.plugloadsolutions.com/psu_reports/HP_DPS_475CBA_475W_Report.pdf				
		nal) 600 watts wide-ranging, active Power Factor Correction, 80% Efficient				
	The Z400 600W power suppl	y efficiency report can be found at this link:				
	http://www.plugloadsolutions	.com/psu_reports/HEWLETT%20PACKARD_626322-				
	001 ECOS%202171.1 600\	N Report.pdf				
Color	Jack Black/Alloy metallic					
Tape Backup		patible tape offerings, please visit:				
	http://www.hp.com/products1	/storage/compatibility/tapebackup/Workstations/index.html				



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Quad/Six-Core Intel® Xeon® Processor 3500/3600 Seri	es with Intel®	64 Archit	ecture	
	Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Υ	Ν		
	Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Υ	Ν		
	Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Υ	Ν		
	Intel Xeon W3550, 3.06GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Υ	Ν		
	Intel Xeon W3565, 3.20GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Υ	Ν		
	Intel Xeon W3670, 3.20GHz, 12MB cache, 1066 memory 4.8GT/s QPI, Six-Core, HT, Turbo	' Y	Ν		
	Intel Xeon W3680, 3.33GHz, 12MB cache, 1333 memory 6.4GT/s, Six-Core, HT, Turbo	' Y	Ν		
	Intel Xeon W3690, 3.46GHz, 12MB cache, 1333 memory 6.4GT/s QPI, Six-Core, HT, Turbo	' Y	Ν		
	HP Liquid Cooling Option is available for all the above pro Intel's numbering is not a measurement of higher performan				

SAS Hard Drives		Option					
		Factory Configured	Option Kit	Kit Part Number	Support Notes		
	HP SAS (Serial Attached SCSI) Hard Drives for HP Works	tations					
	300GB SAS 15K rpm 6Gb/s 3.5" HDD	Ν	Υ	LU967AA			
	450GB SAS 15K rpm 6Gb/s 3.5" HDD	Ν	Υ	LU968AA			
	600GB SAS 15K rpm 6Gb/s 3.5" HDD	Υ	Υ	VM647AA			
	Sub-Section Description/Notes						
	NOTE: SAS controller add-in card required						
	Up to (4) 3.5-inch 15K rpm SAS drives: 300, 450, 600 G	B; 2.4 TB max					
	Removable Boot Drive option						
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstations						
	160GB SATA 7200 rpm 3Gb/s 3.5" HDD	Υ	Υ	PV944A			
	250GB SATA 7200 rpm 3Gb/s 3.5" HDD	Υ	Υ	PY278AA			
	320GB SATA 7200 rpm 3Gb/s 3.5" HDD	Υ	Υ	FH963AA			
	500GB SATA 7200 rpm 3Gb/s 3.5" HDD	Υ	Υ	PV943A			
	1TB SATA 7200 rpm 3.0Gb/s 3.5" HDD	Υ	Υ	GE262AA			
	1.5TB SATA 7200 rpm 3Gb/s 3.5" HDD	Υ	Υ	VH997AA			

Supported Components

Υ	Υ	WE464AA
Υ	Υ	EW222AA
Υ	Υ	FM802AA
Υ	Υ	XP309AA
	Y Y	Y Y Y Y Y Y Y Y Y

Sub-Section Description/Notes

Up to (4) 3.5-inch 7200 rpm SATA drives: 160, 250, 320, 500 GB, 1.0, 1.5, 2.0 TB; 8.0 TB max

Up to (4) 2.5-inch 10K rpm SATA drives: 160, 300, 600 GB; 2.4 TB max

Removable Boot Drive option

SATA Solid State Drives

HP Solid State Drives for Workstations

HP 160GB SATA X25-M SSD	Y	Υ	WV915AA
HP 160GB SATA SSD	Υ	Υ	LZ704AA
HP 300GB SATA SSD	Υ	Υ	LZ069AA
For hard drives, $1 \text{ GB} = 1 \text{ billion bytes}$; $TB = 1 \text{ trillion bytes}$.	Actual for	rmatted cap	acity is less.

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 3.0 Gb/s Controller				
	Integrated SATA 3.0 Gb/s Controller	Υ	Ν		
	Factory integrated RAID on motherboard for SATA	drives			
	RAID 0 Configuration - Striped Array	Υ	Ν		Note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Υ	Ν		Notes 1 and 2
	RAID 1 Configuration - Mirrored Array	Υ	Ν		Note 1
	LSI 9212 4-Port SAS 6Gb/s RAID Card				
	LSI 9212 4-Port SAS 6Gb/s RAID Card	Υ	Υ	XP310AA	Notes 2 and 3
	LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA)			
	LSI 8888ELP 8-port SAS HW RAID Card	Ν	Υ	GE258AA	
	LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID (Card and iBBU(08 Battery Bo	ickup Unit	
	LSI MegaRAID® 9260-8i SAS 6Gb/s ROC RAID Card	Ν	Υ	WE465AA	
	Optional: LSI iBBU08 Battery Backup Unit for LSI 9260-8i	Ν	Υ	LA783AA	

NOTE 1: All drives must be identical in size, speed, and type for RAID arrays.

Specific user-configured hardware SAS RAID configurations are supported on Linux systems. Please visit: http://www.hp.com/support/linux hardware matrix for details.

NOTE 2: In RAID 0 Data Configuration, Boot/OS Drive must be SATA.

NOTE 3: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux_hardware_matrix for details.

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID,



Supported Components

provides excellent functionality and performance and is a good alternative to hardware-based RAID. Please visit: http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

All RAID arrays must be less than 2 TB, except for SATA RAID 0 Data Arrays.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
	Professional 2D					
	NVIDIA Quadro NVS 295 256MB PCle Graphics Card	Υ	Y	FY943AA	Note 1	2
	NVIDIA NVS300 512MB PCle Graphics Card	Υ	Υ	XP612AA	Note 2	2
	AMD FirePro 2270 512MB Graphics Card	Υ	Υ	LA524AA	Note 3	2
	NVIDIA Quadro NVS 450 512 MB PCle Graphics Card	Υ	Υ	FH519AA	Note 4	2
	Entry 3D					
	NVIDIA Quadro FX 380 256MB PCleGraphics Card	Υ	Υ	NB769AA		2
	NVIDIA Quadro 400 512MB Graphics Card	Υ	Υ	LD542AA		2
	NVIDIA Quadro 600 1GB Graphics Card	Υ	Υ	WS093AA		2
	ATI FirePro V3800 512MB PCle Graphics Card	Υ	Y	WL048AA		2
	ATI FirePro V4800 1GB Graphics Card	Υ	Υ	WL049AA		2
	Mid-range 3D					
	NVIDIA Quadro 2000 1GB Graphics Card	Υ	Υ	WS094AA		2
	AMD FirePro V5900 2GB Graphics	Υ	Υ	LS992AA		2
	High End 3D					
	AMD FirePro V7900 2GB Graphics	Υ	Υ	LS993AA		1
	NVIDIA Quadro 4000 2GB Graphics Card	Υ	Υ	WS095AA		1
	NVIDIA Quadro 5000 2.5GB Graphics Card	Υ	Y	WS096AA		1

NOTE 1: If 1st graphics card is NVS 295, 2nd graphics card must be NVS 295

NOTE 2: If 1st graphics card is NVS 300, 2nd graphics card must be NVS 300

NOTE 3: If 1st graphics card is AMD FirePro 2270, 2nd graphics card must be AMD FirePro 2270

NOTE 4: If 1st graphics card is NVS 450, 2nd graphics card must be NVS 450, NVS 295, or NVS 300



Supported Components

High Performance GPU				Option		
Computing		Factory	Option	Kit Part		
		Configured	Kit	Number	Support Notes	
	NVIDIA Tesla C2050 Compute Processor	Υ	Υ	WT428AA	Note 1	
	NVIDIA Tesla C2075 Compute Processor	Υ	Υ	QB035AA	Note 1	
	NOTE 1: Supported only with 600W power supply					

Memory	СТО	Option Kit Part Number	Support Notes
	PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO		
	1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU		

2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 4GB (4x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 12GB (6x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 24GB (6x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 24GB (6x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

Sub-Section Description/Notes

NOTE:DIMMs should be distributed across all three memory channels for optimal performance. Each processor supports up to 3 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

The CPUs determine the speed at which the memory is clocked. If a 1066MHz capable CPU is used in the system, the maximum speed the memory will run at is 1066MHz regardless of the specified speed of the memory.

AMO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO

NOTE: Only unbuffered DDR3 DIMMs are supported.

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAMFX698AA2GB (1x2GB) DDR3-1333 ECC Unbuffered RAMFX699AA4GB (1x4GB) DDR3-1333 ECC Unbuffered RAMNL797AA

Supported Components

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel/Realtek HD ALC262 Audio	Υ	Ν		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	
	Creative X-Fi Titanium PCle Audio Card	Υ	Υ	Υ	Notes 1 and 2

NOTE 1: The SoundBlaster X-Fi Titanium audio card is supported on Windows 7 Professional 32-Bit and 64-Bit and Windows 7 Ultimate 64-bit.

NOTE 2: The SoundBlaster X-Fi Titanium audio card is supported on specific Linux operating systems. Please visit: http://www.hp.com/support/linux hardware matrix for details.

Optical and	Removable
Storage	

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP 16X DVD-ROM SATA Drive	Υ	Υ	AR629AA	Notes 1 and 2
HP 16X DVD+/-RW SuperMulti SATA Drive	Υ	Υ	AR630AA	Note 2
HP Blu-ray Writer	Υ	Υ	AR482AA	Note 3
HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA	

NOTE 2: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

NOTE 3: As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Controller Cards		Factory Optic Configured Kit		Option Kit Part Number	Support Notes
	HP FireWire/IEEE 1394a PCI Card	Υ	Υ	PA997A	
	HP IEEE 1394b FireWire PCle Card	Υ	Υ	NK653AA	
	HP USB 3.0 2x2 Port SuperSpeed PCle x1 Card	Υ	Υ	QT587AA	
	HP SuperSpeed USB 3.0 PCle x1 Card	Υ	Υ	BM867AA	

NOTE 1: Not supported as a 2nd drive option.

Supported Components

Monitors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP LP2065 20-inch LCD Monitor	Υ	Υ	EF227A	
	HP LP2475w 24-inch Widescreen LCD Monitor	Υ	Υ	KD911A	
	HP DreamColor LP2480zx Professional Display	Υ	Υ	GV546A	
	HP LP3065 30-inch Widescreen LCD Monitor	Υ	Υ	EZ320A	
	HP ZR22w 21.5-inch S-IPS LCD Monitor	Υ	Υ	VM626A4	
	HP ZR24w 24-inch S-IPS LCD Monitor	Υ	Υ	VM633A4	
	HP ZR30w 30-inch S-IPS LCD Monitor	Υ	Υ	VM617A4	
	Supported by all Operating Systems available from HP				

Screen Size Diagonally Measured

Broad (PCle)		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Broadcom 5764 PCle LOM Controller	Υ	Ν		
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCle)	Υ	Υ	FS215AA	Note 1
	Intel Gigabit CT Desktop NIC	Ν	Υ	FH969AA	
	NOTE 1 TIVE DOLE THE HEAD	1 57/1	1.4		

NOTE 1: This is a PCI Express card based on the Broadcom 5761 chip.

"Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

The Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC and the Intel Gigabit CT NIC are supported on the following Linux operating systems:

Red Hat Enterprise Linux(RHEL) WS4, 5 Desktop/Workstation

Novell SLED 10 & 11

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Security Cable with Kensington Lock	Ν	Υ	PC766A	
	HP Solenoid Hood Lock & Hood Sensor	Υ	Ν		
	HP (CMT) Solenoid Lock	Ν	Υ	DE618A	
	HP xw4/Z4 Depth Adjustable Fixed Rail Rack Kit	Ν	Υ	EK729AA	



Supported Components

Input Devices		Factory Configured	Option Kit	Option Kit Part Support Number Notes	
	HP PS/2 Standard Keyboard	Υ	Y	DT527A	
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB Smart Card Keyboard	Ν	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	Ν	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	Ν	Υ	EF390AA	

Other Hardware				Option Kit	
		Factory Configured	Option Kit	Part Number	Support Notes
	Configure minitower in desktop orientation	Υ	Ν		
	HP ENERGY STAR 5.0 Enabled Configuration	Υ	Ν		
	HP Workstation Mouse Pad	Y	Ν		Japan only
	HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	
	HP Power Cord Kit	Ν	Υ	DM293A	
	HP Serial Port Adapter	Ν	Υ	PA716A	
	HP Internal USB Port Kit	Ν	Υ	EM165AA	
	HP Optical Bay HDD Mounting Bracket	Ν	Υ	NQ099AA	
	HP Workstation to LTO SAS Int. Cable	Ν	Υ	EH925A	
	HP Z4 Fan and Front Card Guide Kit	Υ	Υ	VH190AA	

Supported Components

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Advisor	Υ	Ν		
	Roxio Easy Media Creator (DVD/Blu-ray Disc burner software)	Υ	Ν		
	Intervideo WinDVD (DVD player/burner software)	Υ	Ν		
	HP ProtectTools Security	Υ	Ν		Note 1
	PDF Complete - Trial Edition	Υ	Ν		
	HP Client Manager Software v6.2 (optional download)	Υ	Ν		
	HP Power Assistant	Υ	Ν		
	MS Office Home & Business 2010	Υ	Ν		
	NOTE 1: Must select as a Configure to Order Option	n. Delivered as	s a "Drop i	n the Box"	CD

Operating Systems Support Notes

Genuine Windows® 7 Ultimate 64-bit	Note 1
Genuine Windows® 7 Professional 32-bit	Note 1
Genuine Windows® 7 Professional 64-bit	Note 1
HP Linux Installer Kit	Note 2
SUSE Linux Enterprise Desktop 11	Note 2
Red Hat Enterprise Linux (RHEL) Workstation - Paper License (1yr)	Note 3

NOTE 1: See http://www.microsoft.com/windows/windows-7/ for support details.

NOTE 2: See: http://www.hp.com/workstations/software/linux

NOTE 3: This second OS must be ordered with the HPIKL as the first OS.



NOTE: Restricted Material Usage updated to match GSE.
ATX 243.84 x 304.8 mm (9.6 x 12 inches)
Single LGA1366
QPI: Up to 6.4GT/sec
Intel® X58 Express
SMSC SCH5327, Rev B
6 DDR3 memory slots
DDR3, UDIMM (Unbuffered), ECC
Channel Interleaved
800MHz, 1066MHz, and 1333MHz DDR3
ECC available on data, parity on address and command

Memory	HP Z400 4-DIMM HP Z400 6-DIMM										
Size (GB)		DIMM1	DIMM2	DIMM3	DIMM4	DIMM1	DIMM2	DIMM3	DIMM4	DIMM5	DIMM6
1		1 GB				1 GB					
2		1 GB	1 GB			1 GB	1 GB				
3		1 GB	1 GB	1 GB		1 GB	1 GB	1 GB			
4		1 GB									
4		2 GB	2 GB			2 GB	2 GB				
6		2 GB	2 GB	2 GB		2 GB	2 GB	2 GB		y y	
8		2 GB									
8		4 GB	4 GB			4 GB	4 GB) (8	
12			N	Α		2 GB	2 GB				
12		4 GB	4 GB	2 GB	2 GB	4 GB	4 GB	2 GB	2 GB		
12		4 GB	4 GB	4 GB		4 GB	4 GB	4 GB			
16		4 GB									
24			N	Α		4 GB	4 GB				

Memory Configuration	 The 4GB DIMM for Z400 and Z600 is NOT compatible with the 4GB DIMMs offered on the Z800. They are NOT interchangeable.
(Supported)	Only ECC DIMMs are supported.
Note on Maximum Memory	*Maximum memory capacities assume 64-bit operating systems, such as genuine Windows® Vista Business 64, XP Professional x64 Edition, Red Hat Linux 64-bit. Genuine Windows Vista Business 32 and XP
Wichiory	Professional (32-bit) support up to 4 GB. 32-bit Linux supports up to 8 GB.
PCI Express	2 x16 PCle Gen2
Connectors	1 x8 PCle (x4)Gen2
	1 x8 PCle (x4) Gen1



PCI Connectors (5.0V)	2 PCI	
Supported Drive Interfaces	SATA	Integrated 6-channel SATA 3.0Gb/sec controller with RAID 0, 1, 5, 10 and NCQ. (Factory integrated RAID is Microsoft Windows only)
	Serial Attached SCSI	Hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit: http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.
	Integrated RAID	NOTE: Requires identical hard drives (speeds, capacity, interface)
	Integrated Graphics	No
	Network Controller	Integrated HP Gbit LAN by Broadcom with the following management capabilities: WOL, PXE 2.1 and ASF 2.0
	External SATA (eSATA)	4 ports are eSATA configurable with optional eSATA After-Market Option cable kit.
	IDE connector	No
	Floppy connector	Yes
	Audio	High Definition Integrated Realtek ALC262 Audio with Line in, Line Out, Microphone, Headphone
	CD-ROM input (Audio)	No
	AUX INPUT (Audio)	Yes
IEEE 1394	Front	6-DIMM Z400: 1 IEEE 1394a standard
Connector(s)	Rear	2 optional IEEE 1394a or IEEE 1394b, requires optional PCI card
	Internal	No
USB Connector(s)	Front	2 USB 2.0
	Rear	6 USB 2.0; 2 USB 3.0, requires optional PCle card
	Internal	4 USB 2.0 ports available by two separate 2x5 headers: supports either up to two HP Internal USB Port Kits, AMO- EM165AA (one port on each Kit), or up to two USB Media Card Readers, or one Internal Port kit and one USB Media Card Reader.
HD Integrated Audio	High Definition Integrated Real	tek ALC262 Audio with Line in, Line Out, Microphone, Headphone
Flash ROM	Yes	
CPU Fan Header	Yes	
Chasiss Fan Header	1 Rear System Chassis Fan He	ader, 1 Optional Front Chassis Fan Header
Front PCI Fan Header	· · · · · · · · · · · · · · · · · · ·	
Front Control Panel/Speaker Header	Yes	
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	Integrated TPM 1.2	
Power Supply Headers	Yes	



System Technical Specifications

Power Switch, Power LED & Hard Drive LED Header	Yes
Clear Password	Yes
Jumper	
Serial Port	Single Port (Requires optional Serial Port Adapter)
Parallel Port	No
Keyboard/Mouse	USB or PS/2
Hood Lock Header	Yes
Hood Sensor Header	Yes

Z400 Required power supply info

Power Supply	475W Cus (Wide Ranging		600W Custom PSU - (Wide Ranging, Active PFC)	
Operating Voltage Range	90 - 26	9 VAC	90 - 26	9 VAC
Rated Voltage Range	100 - 127 VAC 200 - 240 VAC	118 VAC	100 - 127 VAC 200 - 240 VAC	118 VAC
Rated Line Frequency	50-60 Hz	400Hz	50-60 Hz	400Hz
Operating Line Frequency Range	47 - 66 Hz	393-407 Hz	47 - 66 Hz	393-407 Hz
Rated Input Current	10A @ 100-127 VAC 6A @ 200-240 VAC	10A @ 118 VAC	10A @ 100-127 VAC 6A @ 200-240 VAC	10A @ 118 VAC
Heat Dissipation (Configuration & software dependent)	Typical 954 btu/hr Max 1977 btu/hr		Typical 1536 btu/hr (387 kg-cal/hr) Max 2560 btu/hr (645 kg-cal/hr)	
Power Supply Fan	92x25 mm vo	92x25 mm variable speed		ariable speed
ENERGY STAR Qualified (Configuration dependent)	YES		NO	
80 PLUS® Compliant	YES,	85%	YES, 80%	
FEMP Standby Power Compliant @115V (Wake-on LAN disabled) (<2W in S5 - Power Off)	YES		YE	ES .
EuP Compliant @ 230V (<1 W in S5 - Power Off)	YE	YES		ES
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3) (Instantly Available PC) measured at 115V.	<6W		<6	sw
Built-in Self Test LED	YES		YE	ES
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	YE	ES .	YES	

System Configuration



- Technical op		1					
Example Configuration	Processor Info	1x Intel Xeon W3503					
#1	Memory Info		3 1333 (UDI	MM)			
	Graphics Info	NVS295	TA / 1 O	I / O FI			
	Disks/Optical/Floppy PSU	475W 85%	ATA / T Optio	cal / 0 Floppy	1		
Energy Consumption		115 VAC 230 VAC 100 VAC			VΔC		
Lifergy Consumption		-	LAN Disabled	LAN Enabled			LAN Disabled
	Windows Idle (S0)		23 W	85.2		85.9	
	Windows Busy Typ (S0)	140.	90 W	137.8			40 W
	Windows Busy Max (SO)		20 W	152.9	96 W	155.0	00 W
	Sleep (S3)	4.17 W	3.96 W	4.03 W	3.79 W	4.14 W	3.90W
	Off (\$5)	1.25 W	1.14 W	1.51 W	1.35 W	1.23 W	1.12 W
	Zero Power Mode (EuP)	0.3	1 W	0.6	1 W	0.2	9W
Heat Dissipation**		-	VAC	230	VAC		VAC
,		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	294.30) btu/hr	290.99	btu/hr	293.18	B btu/hr
	Windows Busy Typ (S0)	480.89	btu/hr	470.48	B btu/hr	479.19	btu/hr
	Windows Busy Max (S0)	522.87	btu/hr	522.05	btu/hr	529.02	2 btu/hr
	Sleep (S3)	14.2 btu/hr	13.5 btu/hr	13.8 btu/hr	12.9 btu/hr	14.1 btu/hr	13.3 btu/hr
	Off (\$5)	4.27 btu/hr	3.89 btu/hr	5.15 btu/hr	4.61 btu/hr	4.20 btu/hr	3.82 btu/hr
	Zero Power Mode (EuP)	1.04	btu/hr	2.06	otu/hr	0.98 btu/hr	
Example Configuration	Processor Info	1 x Intel Xeo	n W3570				
#2	Memory Info	4x4GB DDR		(UDIMM)			
	Graphics Info	1xFX4800					
	Disks/Optical/Floppy	4x450GB SA	AS / 1 Optico	ıl / 0 Floppy			
	PSU	475W 85%					
Energy Consumption			VAC	230 VAC		100 VAC	
			LAN Disabled	LAN Enabled			LAN Disabled
	Windows Idle (SO)		70 W	178.3			00 W
	Windows Busy Typ (SO)		60 W	393.2		407.	
	Windows Busy Max (SO)	-	80 W	469.		488.0	
	Sleep (S3)	4.84 W	4.65 W	5.13 W	4.94 W	4.85 W	4.66 W
	Off (\$5)	1.18 W	1.07 W	1.61 W	1.37 W	1.16 W	1.05W
	Zero Power Mode (EuP)	i	2 W	0.6			9 W
Heat Dissipation**			15 VAC 230 VAC				VAC
	Windows Idle (S0)		LAN Disabled	LAN Enabled		1	LAN Disabled
	■ Williaows late (30)	010./3	B btu/hr	608.54			btu/hr
		12000	0 htu/h-				
	Windows Busy Typ (S0)	·	0 btu/hr	1341.9		i	0 btu/hr
	Windows Busy Typ (S0) Windows Busy Max (S0)	1647.8	0 btu/hr	1601.0	4 btu/hr	1667.5	9 btu/hr
	Windows Busy Typ (S0) Windows Busy Max (S0) Sleep (S3)	1647.8 16.5 btu/hr	0 btu/hr 15.9 btu/hr	1601.0 17.5 btu/hr	4 btu/hr 16.9 btu/hr	1667.5 16.6 btu/hr	9 btu/hr 15.9 btu/hr
	Windows Busy Typ (S0) Windows Busy Max (S0)	1647.8 16.5 btu/hr 4.03 btu/hr	0 btu/hr 15.9 btu/hr	1601.0	4 btu/hr 16.9 btu/hr 4.68 btu/hr	1667.5 16.6 btu/hr	9 btu/hr 15.9 btu/hr 3.58 btu/hr



Example Configuration	Processor Info	1 x Intel Xeo	n W3520				
#3	Memory Info	3x1GB DDR	3 1333MHz	(UDIMM)			
	Graphics Info	1xFX1800					
	Disks/Optical/Floppy	1x250GB SATA / 1 Optical / 0 Floppy					
	PSU	475W 85%					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	96.7	'0 W	95.1	0 W	97.7	1 W
	Windows Busy Typ (S0)	237.	99 W	233.	03 W	239.0	04 W
	Windows Busy Max (S0)	268.	79 W	267.95 W		274.90 W	
	Sleep (S3)	3.89 W	3.65 W	4.20 W	3.96 W	3.83 W	3.61 W
	Off (S5)	1.20 W	1.06 W	1.51 W	1.35 W	1.17 W	1.02 W
	Zero Power Mode (EuP)	0.3	1 W	0.6	0 W	0.29	9 W
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	330.04	1 btu/hr	324.58	3 btu/hr	333.48	B btu/hr
	Windows Busy Typ (S0)	812.26	6 btu/hr	795.33 btu/hr 815.84 btu/hr		btu/hr	
	Windows Busy Max (S0)	917.38	3 btu/hr	914.51	btu/hr	938.23	B btu/hr
	Sleep (S3)	13.3 btu/hr	12.5 btu/hr	14.3 btu/hr	13.5 btu/hr	13.1 btu/hr	12.3 btu/hr
	Off (\$5)	4.10 btu/hr	3.60 btu/hr	5.15 btu/hr	4.61 btu/hr	3.99 btu/hr	3.48 btu/hr
	Zero Power Mode (EuP)	1.05	btu/hr	2.05	btu/hr	0.97	otu/hr

Example Configuration	Processor Info	1 x Intel Xeo	n W3680	1 x Intel Xeon W3680			
#4	Memory Info	6x2GB DDR	3 1333MHz	(UDIMM)			
	Graphics Info	1xTesla C2050					
	Disks/Optical/Floppy	2x500GB SATA / 1 Optical / 0 Floppy					
	PSU	600W 80%					
Energy Consumption		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	114.	11 W	112.	80 W	113.	10 W
	Windows Busy Typ (S0)	411.	11 W	403	.4 W	409.	50 W
	Windows Busy Max (S0)	460	.0 W	460.	40 W	458.10 W	
	Sleep (S3)	3.67 W	3.41 W	4.12 W	3.85 W	3.64 W	3.41 W
	Off (S5)	1.19 W	1.05 W	1.61 W	1.47 W	1.15 W	1.01 W
	Zero Power Mode (EuP)	0.3	8 W	0.7	9 W	0.3	5W
Heat Dissipation**		115	VAC	230 VAC		100 VAC	
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	389.46	6 btu/hr	384.99	btu/hr	386.01	btu/hr
	Windows Busy Typ (S0)	1403.1	2 btu/hr	1376.80 btu/hr 1397.		1397.6	2 btu/hr
	Windows Busy Max (S0)	1569.9	8 btu/hr	otu/hr 1571.35 btu/hr		1563.5	0 btu/hr
	Cl (C2)	12.53	11.64	14.06	13.14	12.42	11.64
	Sleep (S3)	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr	btu/hr
	Off (\$5)	4.06 btu/hr	3.58 btu/hr	5.49 btu/hr	5.02 btu/hr	3.92 btu/hr	3.45btu/hr
	Zero Power Mode (EuP)	1.31	btu/hr	2.69	btu/hr	1.19	btu/hr



System Technical Specifications

Example Configuration #5 (ENERGY STAR Qualified)	Processor Info Memory Info Graphics Info Disks/Optical/Floppy I/O PSU	1x Intel Xeon W3570 4x2GB DDR3 1333MHz (UDIMM) 1 x FX4800 2x1000GB SATA / 1 Optical / 0 Floppy 1xBroadcom 5761 Gigabit PCle NIC 475W 85%					
Energy Consumption		115	VAC	230	VAC		VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	On-Idle (ENERGY STAR® Idle (S0))	99.	8 W	97.	7 W	100.	.3 W
	ENERGY STAR® PMAX Windows running Linpack and Viewperf	323.	323.1 W 316.6 W		325.4 W		
	ENERGY STAR® "Sleep" (S3)	4.6 W	-	4.8 W	-	4.6 W	-
	ENERGY STAR® "Standby" (Off) (S5)	1.8 W	-	2.1 W	-	1.7 W	-
Heat Dissipation**		115	VAC	230	VAC	100	VAC
		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	On-Idle (ENERGY STAR® Idle (S0))	340.6	btu/hr	333.5	btu/hr	342.3	btu/hr
	ENERGY STAR® PMAX Windows running Linpack and Viewperf		' btu/hr	1080.6 btu/hr		1110.6	btu/hr
	ENERGY STAR® "Sleep" (S3)	15.7 btu/hr	-	16.4 btu/hr	-	15.7 btu/hr	-
	ENERGY STAR® "Standby" (Off) (S5)	1.8 btu/hr	-	2.1 btu/hr	-	1.7 btu/hr	-

NOTES:

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)							
System Configuration	Processor Info	Intel Xeon Processor W3505 2.53 GHz					
(Entry level)	Memory Info 4 x 1GB DDR3 1333 MHz						
	Graphics Info	NVIDIA Quadro NVS 295					
Disks/Optical/Floppy 1 x 160 GB 7200 RPM SATA / DVD-ROM / No Floppy							



^{*} Energy Star low energy mode

^{**} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	3.9 Bels	23 dB
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	4.2 Bels	25 dB
	Floppy Drive Operating (continuous copy)	4.7 Bels	29 dB
	DVD-ROM Operating (sequential reads)	5.1 Bels	38 dB

- <i> </i> - J	Processor Info	Intel Xeon Processor W3570 3.20 GHz
(High-end)	Memory Info	4 x 1GB DDR3 1333 MHz
	Graphics Info	NVIDIA Quadro FX 4600
	Disks/Optical/Floppy 2 x 450 GB 15K SAS / DVD-ROM / No Floppy	

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	4.6 Bels	27 dB
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	5.2 Bels	35 dB
	Floppy Drive Operating (continuous copy)		
	DVD-ROM Operating (sequential reads)	5.3 Bels	38 dB

Environmental Requirements	Temperature	Operating: 5° to 35° C (40° to 95° F) Non-operating: -40° to 60° C (-40° to 140° F)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 3,000 m (10,000 feet) Non-operating: 9,100 m (30,000 feet)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524 m (5,000 ft) altitude, maximum operating temperature is derated by 1° C (1.8° F) per 305 m (1,000 ft) elevation increase



Physical Security an	
Access Panel	Tool-less
	Includes system board and memory information
Optical Drive	Tool-less
Floppy Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 5.56 mm (0.2188 in) diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes



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NIC LEDs (integrated) (Green & Amber)	Yes	
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less	
Power supply diagnostic LED	Yes	
Power Button	Yes, ACPI multi-function	
Power LED	Yes, blue (normal), red (fault)	
Hard drive activity LED	Yes, green	
Internal speaker	Yes	
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.	
Alert Standard Format (ASF) Specification	Version 2.0 support	
	Industry-standard specification for network alerting in operating system-absent environments	
Cooling Solutions	Air cooled forced convection, Optional processor liquid cooling solution	
Power Supply Fans	92 mm x 92 mm x 25 mm 2-wire (non-serviceable)	
CPU Heatsink Fan(s)	Mainstream (<=95W): 80 mm x 80 mm x 15 mm 5-wire PWM Performance (>95W): 92 mm x 92 mm x 25 mm 5-wire PWM	
Chassis Fans	92 mm x 92mm x 25 mm 4-wire PWM	
Memory Fans	No	
HP Vision Diagnostics Offline Edition	HP Vision Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:	
	 Run diagnostics View the hardware configuration of the system 	
	Key features and benefits HP Vision Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest Vision into potential system issues, is the configuration of the system. Vision Diagnostics helps provide higher system availability.	
	Typical uses of the Vision Diagnostics are:	
	 Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis 	
Access Panel Key Lock	No	
ACPI-Ready Hardware	Advanced Configuration and Power Management Interface (ACPI).	
	 Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system 	



Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	No
Power Supply	Requires T15 Torx or flat blade screwdriver
PCI Card Retention	Yes, rear (all), middle (none), front (full-length cards with extender)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder for easy Replacement	Yes
DIMM Connectors for easy Upgrade	Yes
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux

BIOS		
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4	
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.	
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.	
BBS	BIOS Boot Specification v1.01.	
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.	
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.	
BIOS Power On	Users can define a specific date and time for the system to power on.	
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.	
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.	
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).	
SMBIOS	System Management BIOS 2.6, for system management information.	
Boot Control	Disables the ability to boot from removable media on supported devices.	
Memory Change Alert	Alerts management console if memory is removed or changed.	
Thermal Alert	Monitors the temperature state within the chassis. Three modes: • NORMAL - normal temperature ranges • ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown	



Configuration and Power Management Interface) * Enables an operating system to control system power consumption based on the dynamic workload. * Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. * Supports ACPI 2.0 for full compatibility with 64-bit operating systems. * Ownership Tag * A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. * System administrators can power an, restart, and power off a client computer from a remote location. * Shutdown Instantly Available PC (Suspend to RAM - ACPI sleep state S3) * Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server) * Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information. * System board revision level sevision level is digitally encoded into the HW and cannot be modified. * Start-up Diagnostics (Power-on Self-Test) * Auto Setup when new hardware installed * Reystem automatically detects addition of new hardware. * Destate Tag * The user or MIS to set a unique tag string in non-volatile memory. * Par-slot Control * Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. * Adaptive Cooling * Control parameters are set according to detected hardware configuration for optimal acoustics. * Pre-boot Diagnostics * Industry Standard * Revision Support * Advanced Configuration and Power Management Interface, Version 2.0c * Allors tandard Format Specification, Version 2.0	system rechnical spe	:CITICUTIONS
ACPI (Advanced Configuration and Power Management Interface) • Allows the system to enter and resume from low power modes (sleep states). • Enables an operating system to control system power consumption based on the dynamic workload. • Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. • Supports ACPI 2.0 for full compatibility with 64-bit operating systems. • Supports ACPI 2.0 for full compatibility with 64-bit operating systems. A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. Sements Wakeup/Remote Shutdown Instantly Available PC (Suspend to RAM - ACPI sleep state S3) Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server) ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available intrough an industry standard interface (SMBIOS) so that management SW applications can use and report this information. System board revision • Allows management SW to read the revision level of the system board level • Allos starp when new hardware installed Keyboard-less Operation Auto Setup when new hardware installed Keyboard-less Operation Localized ROM Setup The system can be booted without a keyboard. Localized ROM Setup The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Adaptive Cooling Pre-boot Diagnostics (Pre-video) critical errors are reported via beeps and blinks on the power LED. Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Romatopart South of the BIOS ACPI Advanced Configuration and Power Management Interface, Version 3.0 • Enhanced Disk Drive Specification Version 1.0 • Enhanced Disk Drive Specification Version 3.0 • Enhanced Disk Drive Specification Version 3.0 • Entanced Disk Drive Specifi		
Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems. Ownership Tog A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen. Remote Wakeup/Remote Shutdown Instantly Available PC (Suspend to RAM: - ACPI sleep state \$30.) Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server) ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information. System board revision level Start-up Diagnostics Start-up Diagnostics Assesses system health at boot time with selectable levels of testing. Power-on Self-Test) Auto Setup when new hordware installed Keyboard-less Operation Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows no over the network and download software, including the new hordware installed Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows for very low power consumption with elevels of testing. Pre-boot Diagnostics Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 1.0 Enabased Disk Drive Specification Version 1.0 Enabased Side Provision 1.0 Enabased Side Provision 1.0 Enabased Side Provision 1.0 Enabased Side	Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
Remote Wakeup/Remote Shutdown Instantly Available PC (Suspend to RAM - ACP) sleep state S3) Allows for very low power consumption with quick resume time. Allows for very low power consumption with quick resume time. Allows a new or existing system to boot over the network and download software, including the operating system. Allows a new or existing system to boot over the network and download software, including the operating system. Allows a new or existing system to boot over the network and download software, including the operating system. ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information. System board revision level Assesses system beard revision level is digitally encoded into the HW and cannot be modified. Start-up Diagnostics (Prower-on Self-Test) Auto Setup when new hordware installed Keyboard-less Operation The system can be booted without a keyboard. Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Adoptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. (Pre-video) critical errors are reported via beeps and blinks on the power LED. Allows I/O slot parameters (aption ROM enable/disable, bus latency) to be configured individually. Adoptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. (Pre-video) critical errors are reported via beeps and blinks on the power LED. ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 • E		 Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
Instantly Available PC (Suspend to RAM - ACP)	Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Suspend to RAM - ACP sleep state S3	Remote Wakeup/Remote	System administrators can power on, restart, and power off a client computer from a remote location.
Installation via F12 (PXE 2.1) (Remote Boot from Server) ROM revision levels Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information. System board revision level of the system board • Revision level is digitally encoded into the HW and cannot be modified. Start-up Diagnostics (Power-on Self-Test) Auto Setup when new hardware installed Keyboard-less Operation Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Adaptive Cooling Per-boot Diagnostics (Pre-video) critical errors are reported via beeps and blinks on the power LED. Industry Standard Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3.0 • El Torito" Bootable CD-ROM Format Specification Version 1.0 • Enhanced Disk Drive Specification Version 3.0		Allows for very low power consumption with quick resume time.
through an industry standard interface (SMBIOS) so that management SW applications can use and report this information. • Allows management SW to read the revision level of the system board • Revision level is digitally encoded into the HW and cannot be modified. Start-up Diagnostics (Power-on Self-Test) Auto Setup when new hardware installed Keyboard-less Operation The system can be booted without a keyboard. Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Adaptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. Pre-boot Diagnostics Industry Standard Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b EDD • Enhanced Disk Drive Specification Version 1.1 • BIOS Enhanced Disk Drive Specification Version 3.0	Installation via F12 (PXE	
Start-up Diagnostics (Power-on Self-Test)	ROM revision levels	
Auto Setup when new hardware installed	- ·	
hardware installedKeyboard-less OperationThe system can be booted without a keyboard.Localized ROM SetupCommon BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.Asset TagThe user or MIS to set a unique tag string in non-volatile memory.Per-slot ControlAllows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.Adaptive CoolingControl parameters are set according to detected hardware configuration for optimal acoustics.Pre-boot Diagnostics(Pre-video) critical errors are reported via beeps and blinks on the power LED.Industry StandardRevision SupportIndustry StandardRevision Supported by the BIOSACPIAdvanced Configuration and Power Management Interface, Version 2.0cASFAlert Standard Format Specification, Version 2.0ATA (IDE)AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3bCD Boot"El Torito" Bootable CD-ROM Format Specification Version 1.0EDDEnhanced Disk Drive Specification Version 7.0	Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Localized ROM Setup Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings. Asset Tag The user or MIS to set a unique tag string in non-volatile memory. Per-slot Control Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Adaptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. Pre-boot Diagnostics (Pre-video) critical errors are reported via beeps and blinks on the power LED. Industry Standard Specification Support Industry Standard ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 • Enhanced Disk Drive Specification Version 3.0	Auto Setup when new hardware installed	System automatically detects addition of new hardware.
local keyboard mappings. Asset Tag	Keyboard-less Operation	The system can be booted without a keyboard.
Per-slot Control Adaptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. Pre-boot Diagnostics Industry Standard Specification Support Industry Standard ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF AIL Standard Format Specification, Version 2.0 AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot EI Torito" Bootable CD-ROM Format Specification Version 1.1 • BIOS Enhanced Disk Drive Specification Version 3.0	Localized ROM Setup	
Adaptive Cooling Control parameters are set according to detected hardware configuration for optimal acoustics. (Pre-boot Diagnostics Industry Standard Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 EDD • Enhanced Disk Drive Specification Version 3.0	Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Pre-boot Diagnostics (Pre-video) critical errors are reported via beeps and blinks on the power LED. Industry Standard Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "EI Torito" Bootable CD-ROM Format Specification Version 1.0 EDD • Enhanced Disk Drive Specification Version 3.0	Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Industry Standard Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 EDD EDD ENhanced Disk Drive Specification Version 3.0	Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Specification Support Industry Standard Revision Supported by the BIOS ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "EI Torito" Bootable CD-ROM Format Specification Version 1.0 EDD • Enhanced Disk Drive Specification Version 1.1 • BIOS Enhanced Disk Drive Specification Version 3.0	Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
ACPI Advanced Configuration and Power Management Interface, Version 2.0c ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 EDD EDD ENhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0		
ASF Alert Standard Format Specification, Version 2.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 EDD EDD ENhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0	Industry Standard	Revision Supported by the BIOS
ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 EDD Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0	ACPI	Advanced Configuration and Power Management Interface, Version 2.0c
CD Boot "El Torito" Bootable CD-ROM Format Specification Version 1.0 • Enhanced Disk Drive Specification Version 1.1 • BIOS Enhanced Disk Drive Specification Version 3.0	ASF	Alert Standard Format Specification, Version 2.0
 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0 	ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
BIOS Enhanced Disk Drive Specification Version 3.0	CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EHCI Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0	EDD	
	EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0



PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Extensions to Serial ATA 1.5Gb/s, Revision 1.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB	Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 2.0 Specification
	Universal Serial Bus Revision 3.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.6

Eco-Label Certifications &	This product has received or is in the process of being certified to the following approvals and may be
Declarations	labeled with one or more of these marks:
	 ENERGY STAR® (energy-saving features available on selected configurations -Windows only) US Federal Energy Management Program (FEMP) EPEAT Gold® for all ENERGY STAR® configurations. For more details and a list of countries in which this product is registered, please visit the following link: http://www.epeat.net/ProductDisplay.aspx?return=search&action=view&search=true&productid=2478&ProductType=5&epeatcountryid=1 China Energy Conservation Program IT ECO declaration Japan PC Green label*
	*This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'
Batteries	This product complies with ISO standards:
	 EU Directive 91/157/EEC EU Directive 93/86/EEC EU Directive 98/101/EEC
	Batteries used in the product do not contain:
	 Mercury greater than 5ppm by weight Cadmium greater than 10ppm by weight Lead greater than 40ppm by weight
	Battery size: CR2032 (coin cell) Battery type: Lithium
Restricted Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at



	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):
	 Asbestos Batteries - Mercury Batteries - Lead (non-rechargeable) Batteries - Lead (non-rechargeable) Batteries - Non-rechargeable Alkaline and Carbon-Zinc Batteries Batteries - Classification as "Not Restricted" for Transport Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE) Brominated Flame Retardants (all BFRs in external case plastic parts) Cadmium and its compounds Certain Azo Colorants Chlorinated Hydrocarbons Chlorinated Paraffins Formaldehyde Formaldehyde - emissions Hexavalent Chromium and its compounds in metallic applications Hexavalent Chromium and its compounds in non-metallic applications Lead and its compounds Lead in paint Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords Mercury and its compounds Nickel on external surfaces Ozone Depleting Substances (ODS) Polycyclic Aromatic Hydrocarbons (PAH) Perfluorooctane sulfonates (PFOS) in parts Pelfluorooctane sulfonates (PFOS) in preparations Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs) Polychlorinated Naphthalenes Polyvinyl Chloride (PVC) in external case plastic parts
	 Radioactive Substances Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging	HP follows these guidelines to decrease the environmental impact of product packaging:
	 Eliminate the use of heavy metals such as lead, chromium, mercury, and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
Packaging Materials	
Internal	LDPE Foam: .366 kg
External	Cardboard carton and insert: 1.536 kg
End-of-Life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.



Hewlett-Packard Corporate Environmental	For more information about HP's commitment to the environment: Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Information	Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Service, Support and Warranty	On-site Warranty and Service (Note 1): One and three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering
	NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043. This product contains 0% recycled materials (by weight)
	This product is >90% recycle-able when properly disposed of at end of life.

Manageability	
Remote Manageability	Visit: http://www.hp.com/go/easydeploy
Software Solutions	
System Software Manager	Visit: http://www.hp.com/go/ssm
Product Change	Program to proactively communicate Product Change Notifications (PCNs) and Customer
Notification	Advisories by email to customers, based on a user-defined profile.
	PCNs provide advance notification of hardware and software changes to be implemented in the
	factory providing time to plan for transition.
	Customer Advisories provide concise, effective problem resolution, greatly reducing the need to
	call technical support.



Stable & Consistent Offerings

Processors

Product #

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.

HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

	J
NF136AV	Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo
VU898AV	Intel Xeon W3565, 3.20GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo
WH058AV	Intel Xeon W3680, 3.33GHz, 12MB cache, 1333 memory, 6.4GT/s QPI, Six-Core, HT, Turbo
Product #	Offering
FX638AV	HP 250GB SATA 7200 1st HDD
FX648AV	HP 250GB SATA 7200 2nd HDD
FX658AV	HP 250GB SATA 7200 3rd HDD
FX640AV	HP 500GB SATA 7200 1st HDD
FX650AV	HP 500GB SATA 7200 2nd HDD
FX660AV	HP 500GB SATA 7200 3rd HDD
XB107AV	HP 500GB SATA 7200 4th HDD
Product #	Offering
FZ347AV	NVIDIA Quadro NVS 295 256MB Graphics Card
FZ356AV	NVIDIA Quadro NVS 295 256MB Graphics (2nd)
WS070AV	NVIDIA Quadro 2000 1GB Graphics
WS071AV	NVIDIA Quadro 2000 1GB Graphics (2nd)
Product #	Offering
NL980AV	3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM
NL982AV	6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM
NL984AV	12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM
Product #	Offering
Product # FX681AV	Offering HP 16X DVD+-RW SuperMulti SATA 1st Drive
	VU898AV WH058AV Product # FX638AV FX648AV FX658AV FX660AV XB107AV Product # FZ347AV FZ356AV WS070AV WS071AV Product # NL980AV NL982AV

Offering



Stable & Consistent Offerings			
Input Devices	Product #	Offering	
	FX677AV	HP USB Optical Scroll Mouse	
	FZ362AV	HP USB Standard Keyboard	
Operating Systems	Product #	Offering	
	VM432AV	Genuine Windows® 7 Professional 64-bit	



Technical Specifications - Processors

Processors

Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo Intel Xeon W3550, 3.06GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo Intel Xeon W3565, 3.20GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo Intel Xeon W3670, 3.20GHz, 12MB cache, 1066 memory, 4.8GT/s QPI, Six-Core, HT, Turbo Intel Xeon W3680, 3.33GHz, 12MB cache, 1333 memory, 6.4GT/s QPI, Six-Core, HT, Turbo Intel Xeon W3690, 3.46GHz, 12MB cache, 1333 memory, 6.4GT/s QPI, Six-Core, HT, Turbo

Introduction

Intel's latest-generation microarchitecture represents the next step in unprecedented processor performance and dynamic scalability. Designed from the ground up, Intel® Microarchitecture unleashes parallel processing performance technology providing an integrated memory controller and high-speed interconnect per independent processing core.

Performance and Features

Intel® Microarchitecture offers the latest in processor innovation, including:

- Dynamic scalability, managed cores, threads, cache, interfaces, and power for energy-efficient performance on demand
- Design and performance scalability for servers, workstations, notebooks and desktops with support for 2-8+ cores and up to 16+ threads with Intel® Hyper-Threading Technology (Intel® HT Technology), and scalable cache sizes, system interconnects, and integrated memory controllers
- Intel® Turbo Boost Technology delivers additional performance automatically when needed by taking advantage of the processor's power and thermal headroom. This enables increased performance of both multi-threaded and single-threaded workloads.
- Intel Hyper-Threading Technology brings high-performance applications into mainstream computing with 1-16+ threads optimized for a new generation multi-core processor architecture.
- Scalable shared memory of Intel® QuickPath technology features memory distributed to each processor with integrated memory controllers and high-speed point-to-point interconnects to unleash the performance of future versions of next-aeneration Intel® multi-core processors.
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data.

Turbo Boost Technology

This technology, now built into Xeon 3500 Series Quad-Core and Xeon 3600 6-Core processors, will increase the speed of your processor on demand if the CPU is operating below power or thermal specifications:

- Benefit of Turbo Boost (how much the CPU speeds up) depends on number of active cores
- Likelihood of Turbo Boost operation increases when less cores are active and when dynamic power management is enabled



Technical Specifications - Hard Drives

HP SAS (Serial Attached SCSI) Hard Drives for HP Workstations

600GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 600GB
Height 1 in; 2.54 cm
Width Media Diameter

 Media Diameter
 3.5 in; 8.9 cm

 Physical Size
 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.4 ms6.6 ms

Rotational Speed 15,000 rpm

Logical Blocks 1,172,123,568 - 512 byte blocks

Operating Temperature -50° to 95° F (10° to 35° C)

450GB SAS 15K rpm 6Gb/s 3.5" HDD
 Capacity
 450GB

 Height
 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface SAS
Synchronous Transfer 6Gb/s
Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.4 ms6.6 ms

Rotational Speed 15,000 rpm

Operating Temperature 50° to 95° F (10° to 35° C)

300GB SAS 15K rpm 6Gb/s 3.5" HDD Capacity 300GB
Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

InterfaceSASSynchronous Transfer6Gb/s

Rate (Maximum)

Buffer 16MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.4 ms



Technical Specifications - Hard Drives

Rotational Speed 15,000 rpm

50° to 95° F (10° to 35° C) Operating Temperature

SATA (Serial ATA) Hard Drives for HP

Workstations

600GB SATA 10K rpm SFF in 3.5" Frame HDD Capacity 600GB

Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 4 in; 10.17 cm

Serial ATA (3.0Gb/s) Interface Synchronous Transfer Up to 300MB/s

Rate (Maximum)

Buffer 32MB

Cache Segmentable

Seek Time (typical reads, Single Track 0.4 ms (max) includes controller Average 3.6 ms overhead, including Full Stroke 9.0 ms settling)

10,000 rpm **Rotational Speed** Logical Blocks 1,172,123,568

41° to 131° F (5° to 55° C) Operating Temperature

300GB SATA 10K rpm SFF in 3.5" Frame HDD Capacity 300,069,052,416 bytes

Height 1 in; 2.54 cm

Width Media Diameter 2.5 in; 6.36 cm Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing enabled

Synchronous Transfer

Rate (Maximum)

Logical Blocks

Interface

Up to 300 MB/s

Cache 16 MB

0.7 ms (maximum) Seek Time (typical reads, Single Track includes controller Average 4.4 ms overhead, including Full Stroke 9.5 ms

settling) **Rotational Speed** 10,000 rpm

41° to 131° F (5° to 55° C) Operating Temperature

160GB SATA 10K rpm SFF in 3.5" Frame HDD Capacity 160,041,885,696 bytes

Height 1 in; 2.5 cm

Width Media Diameter 2.5 in; 6.36 cm

586,072,368

Physical Size 4 in; 10.17 cm Serial ATA (1.5 Gb/s), Native Command

Queuing enabled



Technical Specifications - Hard Drives

Synchronous Transfer Up to 300 MB/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, Single Track 0.7 ms (maximum)

includes controller overhead, including settling)

Average 4.4 ms

Full Stroke 9.5 ms

Rotational Speed 10,000 rpm Logical Blocks 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 3Gb/s 3.5" HDD Capacity 2.0TB
Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing Enabled Up to 300MB/s

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, Single Track 1.0 ms includes controller overhead, including 10 ms

settling) Full Stroke Not Specified

Rotational Speed 7,200 rpm Logical Blocks 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

1.5TB SATA 7200 rpm 3Gb/s 3.5" HDD Capacity 1.5TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing enabled

Synchronous Transfer Up to 300MB/s Rate (Maximum)

- "

Buffer 32MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 msAverage
Full Stroke11 ms

Rotational Speed 7,200 rpm Logical Blocks 2,930,277,168

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications - Hard Drives

1TB SATA 7200 rpm 3.0Gb/s 3.5" HDD

Capacity 1,000,204,886,016 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

> Queuing enabled Up to 300 MB/s

Synchronous Transfer

Rate (Maximum)

32 MB

Buffer

Single Track Seek Time (typical reads, 2 ms includes controller 11 ms Average overhead, including Full Stroke 21 ms

settling)

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

41° to 131° F (5° to 55° C) Operating Temperature

500GB SATA 7200 rpm 3Gb/s 3.5" HDD

500,107,862,016 bytes Capacity

Height 1 in; 2.5 cm

3.5 in; 8.9 cm Width Media Diameter

> Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing enabled

Synchronous Transfer

Rate (Maximum)

300 MB/s

Buffer 16 MB

Seek Time (typical reads, Single Track 2 ms includes controller 11 ms Average overhead, including Full Stroke 21 ms settling)

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

320GB SATA 7200 rpm 3Gb/s 3.5" HDD

Capacity 320,072,933,376 bytes

0.98 in; 2.5 cm Height

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

300 MB/s

Queuing enabled

Synchronous Transfer

Rate (Maximum)

Buffer 8 MB



Technical Specifications - Hard Drives

Seek Time (typical reads, Single Track 2 ms includes controller 12 ms Average overhead, including Full Stroke 21 ms settling)

Rotational Speed 7,200 rpm 625,142,448 Logical Blocks

Operating Temperature 41° to 131° F (5° to 55° C)

250GB SATA 7200 rpm 3Gb/s 3.5" HDD

Capacity 250,059,350,016 bytes Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command

300 MB/s

Queuing enabled

Synchronous Transfer Rate (Maximum)

Buffer

Seek Time (typical reads, Single Track 2 ms includes controller Average 11 ms overhead, including **Full Stroke** 21 ms settling)

8 MB

Rotational Speed 7,200 rpm 488,397,168 Logical Blocks

Operating Temperature 41° to 131° F (5° to 55° C)

160GB SATA 7200 rpm 3Gb/s 3.5" HDD

Capacity 160,041,885,696 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command

Queuing enabled

300 MB/s Synchronous Transfer

Rate (Maximum)

Buffer 8 MB

2 ms Seek Time (typical reads, Single Track includes controller Average 11 ms overhead, including Full Stroke 21 ms settling)

Rotational Speed 7,200 rpm 312,581,808 Logical Blocks

41° to 131° F (5° to 55° C) Operating Temperature

2.5 in; 6.36 cm

QuickSpecs

Technical Specifications - Hard Drives

HP Solid State Drives for HP 160GB SATA SSD

Workstations

160GB Capacity

Width Media Diameter NaN in; NaN cm

Physical Size

SATA Interface 3Gb/s Synchronous Transfer

Rate (Maximum)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 300GB SATA SSD Capacity 300GB

> Width Physical Size 2.5 in; 6.36 cm

Interface **SATA** Synchronous Transfer 3Gb/s

Rate (Maximum)

32° to 158° F (0° to 70° C) Operating Temperature

HP 160GB SATA X25-M

SSD

160,041,885,696 bytes Capacity

Height 0.28 in; 0.7 cm

Width Media Diameter NaN in; N/A cm 2.5 in; 6.36 cm

Physical Size

Interface **SATA** Synchronous Transfer 3Gb/s

Rate (Maximum)

Read: 75 **Seek Time** (typical reads, Average

includes controller

overhead, including settling)

microseconds; Write: 85 microseconds

Logical Blocks 312,581,808

Operating Temperature 32° to 158° F (0° to 70° C)

Technical Specifications - Hard Drive Controllers

LSI 9212 4-Port SAS 6Gb/s RAID Card PCI Bus 8-lane, 5GT/s PCI Express 2.0

PCI Modes

RAID Levels

Bus Master DMA

RAID 0, 1, 1E and 10

PCI Data Burst Transfer Half Duplex, x4 PCle 2000 MB/s Rate Full Duplex, x8 PCle 4000 MB/s

SAS Bandwidth Half Duplex Single lane - 600 MB/s

Wide Port (2 lanes) - 1200 MB/s Wide Port (4 lanes) - 2400 MB/s Single SAS Lane - 1200 MB/s

Full Duplex Single SAS Lane - 1200 MB/s

Wide Port (2 lanes) -2400 MB/s Wide Port (4 lanes) - 4800 MB/s

PCI Card Type3.3V Add-in cardPCI Voltage $12 V \pm 10\%$ PCI Power13.5 Watts

Bracket Full height and Low-profile

Certification Level PCI-Express 2.0
IO Bus 1x4 6Gb/s SAS ports

SAS Processor LSISAS2008 Internal Connectors Four x1 SATA

External Connectors None Maximum Number of 256

LED Indicators Inte

SCSI Devices

Rate

Activity/Fault per x4 port - Heartbeat

LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA) PCI Bus PCI-Express x8 lanes
PCI Modes Bus Master DMA
RAID Levels RAID 0, 1, and 5
RAID spans 10 and 50

PCI Data Burst Transfer Up to 3Gb/s per port

Full Duplex Up to 1.5 GB/s
PCI Voltage +3.3V Add-in Card
PCI Power 19.2 Watts Maximum

Certification Level PCI-Express 1.0a

IO Bus Eight 3Gb/s SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4
External Connectors Two SAS SFF8088 x4

Maximum Number of 32

SCSI DeviceS

LED Indicators Connector LEDs indicate whether the internal or external connector is active

for ports 0-3 and 4-7



Technical Specifications - Hard Drive Controllers

LSI MegaRAID® 9260-8i PCI Bus SAS 6Gb/s ROC RAID PCI Mod Card and iBBU08 Battery Backup Unit RAID Le

PCI Bus PCI-Express (Gen2) V2.0 x8 lanes

Up to 4GB/s

PCI Modes

Bus Master DMA

RAID Levels

RAID 0, 1, 5, and 6

RAID spans 10, 50 and 60

PCI Data Burst Transfer

Rate

PCI Card Type

Low profile, single PCIe slot design with full height bracket.

The optional iBBU08 Battery Backup unit mounts on the controller card and

the assembly remains within a single PCle slot width.

PCI Voltage +3.3V Add-in Card

PCI Power 12.5 Watts
Certification Level PCI-Express 2.0

IO Bus Eight 3 Gb/s and 6Gb/s compatible SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4

External Connectors None Maximum Number of 32.

SCSI Devices NOTE: HP Workstations do not support this many internal drives.

LED Indicators Connector LEDs indicate whether the internal connector is active for ports 0-

3 and 4-7



Technical Specifications - Graphics

NVIDIA Quadro NVS 295 Form Factor

256MB Graphics Card

actor 2.731 inches (H) \times 6.600 inches (L), Half-Height

Graphics Controller NVIDIA Quadro NVS 295 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort

Comes with 2 DisplayPort to DVI-D Adapters

('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an

accessory)

Maximum Resolution Two DisplayPort outputs drive two digital displays up to 2560 x 1600

NOTE: This card supports up to two displays

Display Output

 Drives DisplayPort enabled digital displays at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking

ullet Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single

link) cable)

Supported Graphics APIs

OpenGL 3.0 DirectX 10.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation (64-bit and 32-bit)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <24 Watts



Technical Specifications - Graphics

NVIDIA NV\$ 300 512MB Form Factor

Graphics Card

Bus Type

Graphics Controller

2.7 inches (H) x 5.7 inches (L), Half-Height

NVIDIA NVS 300 Graphics Board PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 SDRAM unified graphics memory

Connectors **DMS-59**

Includes DMS-59 to Dual DVI-I adapter

DMS-59 to Dual DisplayPort adapter and DMS-59 to Dual VGA adapter

available as an option

DMS-59 to Dual DisplayPort adapter required for HP ZR30w Display

Maximum Resolution DVI: two digital displays up to 1920 x 1200

> DisplayPort: two digital displays up to 2560 x 1600 VGA: two analog displays up to 1920 x 1080

Image Quality Features

Display Output

This card support up to two displays:

 \bullet Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking

• Drives DisplayPort enabled digital displays at resolutions up to 2560 imes 1600 at 60 Hz with reduced blanking (through optional DMS-59 to DisplayPort adapter)

 Drives VGA enabled analog displays at resolutions up to 1920 x 1080 (through optional DMS-59 to VGA adapter)

OGL 3.3 Supported Graphics APIs

DirectX 10.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <18 Watts



Technical Specifications - Graphics

AMD FirePro 2270 512MB Graphics Card Form Factor Low Profile, Half Length, 2.3" x 6.6"

Graphics Controller AMD FirePro[™] 2270 Professional Graphics

Bus Type PCI Express[™] x16 Generation 2.0

Memory 512MB DDR3

Connectors DMS-59 connector to support breakout cables for dual DisplayPort, DVI and

VGA output.

DMS-59 to Dual DVI adapter included.

(Display Port and VGA adapters sold separately)

Maximum Resolution Digital 2560x1600 (DisplayPort)

Analog 1920x1200 (DVI 60 Hz/ VGA 75Hz)

RAMDAC 400 MHz DAC, 10-bit per channel
Display Output Card supports up to two displays
Supported Graphics APIs DirectX 11 and OpenGL 4.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption 17W Maximum

NVIDIA Quadro NVS 450 Form Factor

512 MB PCle Graphics

Card

ATX Full Height, 1/2 length

Passive cooling

Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 (256MB per GPU)

Connectors Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution DisplayPort connectors support ultra-high-resolution panels (up to 2560 x

1600)

NOTE: This card supports up to four displays

Supported Graphics APIs OpenGL 3.0

DirectX 10.0

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Microsoft Windows Vista (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Graphics

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption <40 Watts

NVIDIA Quadro FX 380 256MB Graphics Card Form Factor 4.376 inches (H) \times 6.60 inches (L)

Graphics Controller NVIDIA Quadro FX 380 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 Dual-Link DVI-I

Two DVI to VGA adapters included

Maximum Resolution Two dual-link DVI-I outputs drive two digital displays at resolutions up to

2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x

1536 @ 85Hz

NOTE: This card supports up to two displays

RAMDAC Dual Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

• Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs

OpenGL 3.0 DirectX 10.0

Available graphics drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power consumption 34 Watts

Technical Specifications - Graphics

NVIDIA Quadro 400 512MB Graphics Card Form Factor Low Profile, 2.7 inches (H) x 5.6 inches (L)

Graphics Controller NVIDIA Quadro 400 Graphics Board

Bus Type PCI Express x 16, Generation 2.0

Memory 512MB DDR3 SDRAM
Connectors One (1) Dual-link DVI-I
One (1) DisplayPort 1.1

Includes one DisplayPort to DVI-D adapter

Maximum Resolution DisplayPort 1.1: 2560 x 1600 @ 60 Hz

Dual Link DVI-I: 2560 x 1600 @ 60 Hz

Analog: 2048 x1536 @ 85 Hz

RAMDAC Dual internal 400 MHz DACs

Display OutputThis card supports up to two displays

Supported Graphics APIs OpenGL 3.2

DirectX 10.1 Shader Model 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption < 35 Watts

NVIDIA Quadro 600 1GB Graphics Card Form Factor 2.731" H x 6.6" L

Single Slot

Small Form Factor

Graphics Controller NVIDIA Quadro 600 Graphics Card

Bus Type PCI Express 2.0 x16
Memory 1 GB GDDR3

128-bit

Connectors 1 DVI-I output, 1 DisplayPort output

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Shading Architecture Shader Model 5.0



Technical Specifications - Graphics

Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 and Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 40 Watts

ATI FirePro V3800 512MB Graphics Card Form Factor

2.71 in (H) x 6.61 in (L) "Single-Wide"

Graphics Controller ATI FirePro V3800 Graphics Board
Bus Type PCI Express x16, Generation 2.0

Memory 512 MB DDR3 SDRAM
Connectors 1 DL DVI, 1 DP output

One DP to DVI adapter included

Maximum Resolution Up to two digital dis

Up to two digital displays at resolutions up to 2560 x 1600 @ 60Hz or two analog displays, one at resolutions up to 2048 x 1536 @ 85Hz, the other at

up to 1920 x 1200 @ 60Hz (165 MHz dot clock) NOTES: This card supports up to two displays

Use of more than two displays on Linux requires support for xrandr 1.2 or

greater in the X server

RAMDAC

400 MHz DAC, 10-bits per channel

Image Quality Features

- Full 30-bit display pipeline for more accurate color reproduction superior image quality (30-bit monitor required for full 30-bit display)
- Advanced video capabilities, including high fidelity gamma, color correction and scaling
- Dedicated hardware (UVD2) for H.264, VC-1, and MPEG2 decode

Shading architecture

- Support for Full Shader Model 5.0
- 400 Stream Processing Units
- Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders
- Common instruction set and texture unit access supported for all types of shaders
- Dedicated branch execution units and texture address processors
- Anti-aliases Shaders and Textures as well as Polygon Edges



Technical Specifications - Graphics

Supported graphics APIs DirectX 11, OpenGL 3.2, OpenCL 1.0 and full implementation of

DirectCompute 11

(OpenCL[™] compliant driver and SDK release scheduled in 2010)

Available graphics drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) WS4
* WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux(RHEL) 5 Desktop/Workstation Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption 43 Watts

ATI FirePro V4800 1GB Graphics Card Form Factor $4.37 \text{ in (H)} \times 6.61 \text{ in (L)}$

Graphics Controller ATI FirePro V4800 Graphics Card
Bus Type PCI Express x 16, Generation 2.0

Memory 1 GB GDDR5 SDRAM

Connectors 2 DisplayPort, 1 dual link DVI Output

One DP to DVI adapter included

Maximum Resolution Up to three digital displays at resolutions up to 2560 x 1600 @ 60Hz or up

to three analog displays, one at resolutions up to 2048 x 1536 @ 85Hz, plus two resolutions up to 1920 x 1200 @ 60Hz (165 MHz dot clock)

NOTE: This card supports up to three displays with Windows 7, Vista or

Linux, and up to two displays on XP

RAMDAC

400 MHz DAC, 10-bit per channel

Image Quality Features

 Up to 3 independent outputs with ATI Eyefinity technology support (More information at:

www.amd.com/us/products/technologies/eyefinity/)

- Full 30-bit display pipeline for more accurate color reproduction superior image quality2
- Advanced video capabilities, including high fidelity gamma, color correction and scaling
- Dedicated hardware (UVD2) for H.264, VC-1, and MPEG2 decode

NOTE: The use of more than two displays on Linux requires support for xrandr 1.2 or greater in the X server

Shading architecture

- Support for Full Shader Model 5.0
- Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders
- Common instruction set and texture unit access supported for all types of shaders
- Dedicated branch execution units and texture address processors
- Anti-aliases Shaders and Textures as well as Polygon Edges



Technical Specifications - Graphics

Supported graphics APIs DirectX 11, OpenGL 3.2, OpenCL 1.03 and full implementation of

DirectCompute 11

(OpenCL[™] compliant driver and SDK release scheduled in 2010)

Available graphics drivers Genuine Windows 7 Professional (64-bit and 32-bit)

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux(RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 & Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption 69 Watts

NVIDIA Quadro 2000 1GB Graphics Card Form Factor 4.376" H x 7" L

Single Slot

Graphics Controller

NVIDIA Quadro 2000 Graphics Card

Bus Type Memory PCI Express 2.0 x16

1 GB GDDR5 128-bit

Connectors

1 DVI-I output, 2 DisplayPort outputs

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

• Support for any combination of two connected displays

DisplayPort 1.1a, HDMI 1.3a, and HDCP support

 NVIDIA® 3D Vision[™] technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL guad buffered stereo support

• Underscan/overscan compensation and hardware scaling

NVIDIA® nView® multi-display technology

Shading Architecture

Shader Model 5.0



Technical Specifications - Graphics

Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 and Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

62 Watts **Power Consumption**

AMD FirePro V5900 2GB Form Factor

Graphics Card

Full-height, full length, single slot

AMD FirePro™ V5900 Professional Graphics **Graphics Controller**

Bus Type PCI Express[™] x16, Generation 2.1

2GB GDDR5 Memory

Connectors 2 x Display Port 1.2

1 x Dual-link DVI

Maximum Resolution 2560 x 1600

Display Output DirectX 11 and OpenGL 4.1 Supported Graphics APIs

Available Graphics

Drivers

DirectX 11 and OpenGL 4.1

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

Linux® (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

< 75 W

Note

Monitors should be same model when using DP-DVI connections to use the Eyefinity feature. There are no additional limitations when using DisplayPort

cables.

Technical Specifications - Graphics

AMD FirePro V7900 2GB Form Factor

Graphics Card

Form Factor Full height, full length, single slot

Graphics Controller AMD FirePro™ V7900 Professional Graphics

Bus Type PCI Express™ x16, Generation 2.1

Memory 2GB GDDR5

Connectors 4 x DisplayPort 1.2

Maximum Resolution 2560 x1600

Supported Graphics APIs

DirectX 11 and OpenGL 4.1

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Linux® (32-bit or 64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Power Consumption

Note

< 150W

Monitors should be same model when using DP-DVI connections to use the Eyefinity feature. There are no additional limitations when using DisplayPort

cables.

NVIDIA Quadro 4000 2GB Graphics Card Form Factor 4.376" H x 9.50" L

Single Slot

Graphics Controller

NVIDIA Quadro 4000 Graphics Card

Bus Type PCI Express 2.0 x16
Memory 2 GB GDDR5

256-bit

Connectors 1 DVI-I output, 2 DisplayPort outputs;

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI (single- link or dual-

link) adapters available as accessories

(Optional stereo bracket available from 3rd party)

Maximum Resolution Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz)

Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

RAMDAC 400 MHz integrated RAMDAC

Image Quality Features

• Up to 16K x16K texture and render processing

Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

128-bit floating point performance

• 32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

 NVIDIA 3D Vision[™] technology, 3D DLP, Interleaved, and other 3D stereo format support

• Full OpenGL quad buffered stereo support

• Underscan/overscan compensation and hardware scaling



Technical Specifications - Graphics

• NVIDIA nView® multi-display technology

Shading Architecture
Supported Graphics APIs

Shader Model 5.0 OpenGL 4.0 DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics Drivers Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 and Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption

142 Watts

NVIDIA Quadro 5000 2.5GB Graphics Card Form Factor 4.376" H x 9.75" L

Dual Slot

Graphics Controller

NVIDIA Quadro 5000 Graphics Card

Bus Type

PCI Express 2.0 x16

Memory 2.5 GB GDDR5

320-bit

Connectors

DVI-I (1), DP (2), Stereo (1)

One DP to DVI adapter included with card

DVI to VGA, DisplayPort to VGA and DisplayPort to DVI adapters available

as accessories

Maximum Resolution

Dual DisplayPort (up to 2560 x 1600 @ 60Hz and 1920x1200 @ 120Hz) Dual-link DVI-I output (up to 2560 x 1600 @ 60Hz and 1920x1200 @

120Hz)

Image Quality Features

• Up to 16K x16K texture and render processing

• Transparent multisampling and super sampling

• 16x angle independent anisotropic filtering

• 128-bit floating point performance

32-bit per-component floating point texture filtering and blending

Support for any combination of two connected displays

• DisplayPort 1.1a, HDMI 1.3a, and HDCP support

 NVIDIA 3D Vision[™] technology, 3D DLP, Interleaved, and other 3D stereo format support

Full OpenGL guad buffered stereo support

Underscan/overscan compensation and hardware scaling



Technical Specifications - Graphics

• NVIDIA nView® multi-display technology

Shading Architecture Shader Model 5.0 Supported Graphics APIs OpenGL 4.0

DirectX 11

CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Available Graphics

Drivers

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit) Red Hat Enterprise Linux (RHEL) WS4 (64-bit and 32-bit)

* WS4 not supported on Z200 and Z200 SFF

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 6 Desktop/Workstation SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power Consumption 152 Watts

Technical Specifications - High Performance GPU Computing

NVIDIA Tesla C2050 Compute Processor Form Factor 4.376 inches by 9.75 inches

Dual Slot

System Interface PCI Express Gen2 ×16
Video Outputs One Dual Link DVI-I

(Consumer graphics level of performance)

Memory 3GB GDDR5
Peak Memory Bandwidth +170 GB/s

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit and 32-bit) Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux (RHEL) 5 Desktop/Workstation (64-bit and 32-bit)

SUSE Linux Enterprise Desktop 11 (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores 448 CUDA cores
Power Consumption ∼225 Watts

NOTE 1: An 1110W PSU is required for Tesla C2050 on the Z800 NOTE 2: A 600W PSU is required for Tesla C2050 on the Z400

NVIDIA Tesla C2075 Compute Processor Form Factor 4.376 inches by 9.75 inches

Dual Slot

System Interface PCI Express Gen2 ×16
Video Outputs One Dual Link DVI-I

(Entry graphics level of performance)

Memory 6GB GDDR5
Peak Memory Bandwidth +170 GB/s

Supported APIs CUDA API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and

Fortran

Supported Operating

Systems

Genuine Windows 7 Professional (64-bit) Genuine Windows Vista Business (64-bit) Microsoft Windows XP Professional (64-bit)

Red Hat Enterprise Linux (RHEL) 5, 6 Desktop/Workstation (64-bit)

SUSE Linux Enterprise Desktop 11 (64-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html



Technical Specifications - High Performance GPU Computing

Novell SUSE Linux Enterprise drivers may also be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Processor Cores 448 CUDA cores
Power Consumption ∼215 Watts

NOTE 1: An 1110W PSU is required for Tesla C2075 on the Z800 NOTE 2: A 600W PSU is required for Tesla C2075 on the Z400



Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered

Frequency Response (-3dB, 24-bit/96kHz input) FO to 20kHz

Speakers

Dimensions

Speakers: 14.52 x 9.50 x 2.45 cm (5.72 x 3.74 x 0.96 in) per speaker

SoundBlaster (Creative Labs) X-Fi Titanium PCle **Audio Card**

24-bit Analog-to-Digital conversion of analog

96kHz sample rate

inputs

24-bit Digital-to-Analog

96kHz to analog 7:1 speaker output

conversion of digital

sources

8, 11.025, 16, 22.05, 24, 32, 44.1, 48 and 96kHz

24-bit Digital-to-Analog conversion of stereo digital sources

16-bit to 24-bit recording 16-bit/44.1kHz, 16-bit/48kHz, 24-bit/44.1kHz, 24-bit/48kHz and 24-

sampling rates

bit/96kHz with direct monitoring

support

Enhanced SoundFont Up to 24-bit resolution

Signal-to-Noise Ratio

109dB

(2okHz Low-pass filter, A-

Weighted)

Total Harmonic Distortion .004%

+ Noise at 1kHz (20kHz

Low-pass filter)

Frequency Response (-10Hz to 46kHz

3dB, 24-bit/96kHz input) Frequency Response (-

10Hz to 46kHz

3dB, 24-bit/192kHz input)

Speaker and Headphone Stereo to 7.1 (Line Out via three 3.5mm mini jacks)

connections

Flexijack Line In/ Microphone In/Optical Out via shared 3.5mm mini jack

Front Panel Header Intel HD Audio Compatible (2x5 pin) Windows 7 Professional 32-bit and 64-bit **Operating System**

Microsoft Windows Vista Business 32-bit and 64-bit

Microsoft® Windows® XP Professional SP2 Microsoft Windows XP Professional x64 Edition

Minimum System Requirements

System RAM 512MB

Operating System Windows Vista 32-bit and 64-bit version or

Windows XP 32-bit or 64-bit version

Technical Specifications - Optical and Removable Storage

NOTE 1: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

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5.25-inch, half-height, tray-load Description Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

> CD-ROM Mode 1 < 125 ms (typical) Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Power Source SATA DC power receptacle

> DC Power Requirements $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

> > 12 VDC ± 5%-200 mV ripple p-p

DC Current 5 VDC - < 1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

10% to 90%

30° C (86° F)

Operating Environmental Temperature 5° to 50° C (41° to 122° F)

(all conditions non-

Relative Humidity condensing)

Maximum Wet Bulb

Temperature

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*, Windows Vista

Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation,

Removed reference to "Novell" because of acquisition and changed product reference to "SUSE Linux Enterprise Desktop 10 & 11", No driver is required for this device. Native support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/ getready/hardwareregs.mspx and http://www.microsoft.com/windowsvista/ getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:



Technical Specifications - Optical and Removable Storage

http://www.windowsvista.com/upgradeadvisor.
For Windows Vista system requirements, visit:
http://www.windowsvista.com/systemrequirements.

** RHEL WS4 not supported on Z200/Z200SFF

HP DVD+/-RW Drive Description 5.25-inch, half-height, tray-load

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats DVD-RAM

DVD+R
DVD+R DL
DVD-R DL
DVD-R
DVD-R
DVD-RW
CD-R
CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

DVD+RWUp to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+RUp to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

DC Power Requirements $\,$ 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -1000 mA typical, 1600 mA maximum

12 VDC -600 mA typical, 1400 mA maximum

Operating Environmental Temperature 5° to 50° C (41° to 122° F)

(all conditions non-condensing)

Relative Humidity

10% to 90%

Admirator NATA Bulls

20% C (96% E)

Maximum Wet Bulb 30° C (86° F) Temperature

Operating Systems Windows 7 Professional 32-bit and 64-bit,

Supported Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*,

Technical Specifications - Optical and Removable Storage

Windows 2000, Windows XP Professional or Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

Desktop/Workstation

SUSE Linux Enterprise Desktop 10 & 11

No driver is required for this device. Native support is provided by the operating system.

*Certain Windows Vista product features require advanced or additional hardware. See http://microsoft.com/windowsvista/ getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/

getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:

http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit:

http://www.windowsvista.com/systemrequirements

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents

HP SATA SuperMulti DVD Writer Drive, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.

HP Blu-Ray Writer

Description

5.25-inch, half-height, tray-load

Mounting Orientation

Either horizontal or vertical

Interface Type

SATA

Dimensions (WxHxD)

15.0 x 4.4 x 20.3 cm (5.9 x 1.7 x 8.0 in)

Disc Formats

BD-ROM BD-R

BD-RE
DVD-RAM
DVD+R
DVD+RW
DVD+R DL
DVD-R DL
DVD-R

DVD-RW CD-R CD-RW

Disc Capacity

DVD-ROM 8.5 GB DL or 4.7 GB standard

Blu-ray 50 GB DL or 25 GB standard

Blu-ray Blu-ray

Startup Time (Time to BD-ROM (SL/DL) 25S / 28S



Technical Specifications - Optical and Removable Storage

ons opinear and nen	lovable blorage			
	drive ready from tray	BD-R (SL/DL)	25\$ / 28\$	
	loading)	BD-RE (SL/DL)	25\$ / 28\$	
		DVD-ROM (SL/DL)	185 / 185	
		DVD-R (SL/DL)	25\$ / 25\$	
		DVD-RW	25\$	
		DVD+R (SL/DL)	25\$ / 25\$	
		DVD+RW	25\$	
		DVD-RAM	45S	
		CD-ROM	45S	
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X	
Rates		CD-R	Up to 40X	
		CD-RW	Up to 40X	
	DVD ROM Read	DVD-RAM	Up to 5X	
		DVD+RW	Up to 10X	
		DVD-RW	Up to 10X	
		DVD+R DL	Up to 8X	
		DVD-R DL	Up to 8X	
		DVD-ROM	Up to 16X	
		DVD-ROM DL	Up to 8X	
		DVD+R	Up to 12X	
		DVD-R	Up to 12X	
	Blu-Ray	BD-ROM	Up to 6X	
		BD-ROM DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-R DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-RE SL/DL	Up to 4.8X	
Power	Source	SATA DC power receptacle		
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p		
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum		
Operating Environmental	Temperature	5° to 50° C (41° to 122° F)		
(all conditions non-	Relative Humidity	15% to 80%		
condensing)	Maximum Wet Bulb Temperature	30° C (86° F)		
	Operating Systems	Windows 7 Professional 32-bit and 64-bit,		
	Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*,		
		Windows 2000, Windows XP Professional or Windows XP Home 32*.		



Red Hat Enterprise Linux(RHEL) WS4**, 5, 6

SUSE Linux Enterprise Desktop 10 & 11

Desktop/Workstation,

Technical Specifications - Optical and Removable Storage

* No driver is required for this device. Native support is provided by the operating system.

** RHEL WS4 not supported on Z200/Z200SFF

Kit Contents

HP Blue Laser RW Drive, Roxio Easy Media Creator software, Intervideo WinDVD Software,

installation guide.

Disclaimer

As Blu-Ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support.

HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card Reader Description

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

Mounting Orientation

The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will operate in any orientation.

Interface Type

USB 2.0 (one channel dedicated to the separate USB port; one channel dedicated to the flash memory card slots)

dedicated to the flash memory

Dimensions (WxHxD)

124.5 x 101.6 x 25.4 mm (4.9 x 4.0 x 1.0 in)

Disc Formats

xD-Picture Micro SD Micro SDHC

SD SDHC SDXC Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)



Technical Specifications - Optical and Removable Storage

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied): MMC Micro Memory Stick Micro (M2)



Technical Specifications - Controller Cards

HP FireWire/IEEE 1394a Data Transfer Rate PCI Card

Burst Data Rate up to 400 Mbps

Device Interface Protocol IEEE-1394a

Devices Supported IEEE-1394 compliant devices

Bus Type PCI card with brackets for low profile and full height PCI slots.

Certification Level FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Ports Two IEEE 1394 6-Pin Connector (Rear)

Internal Connectors One 10-Pin (9 Contacts) Custom Connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64*,

Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided by the operating system. * Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Pentium II 266 or above

128-MB RAM 1-GB Hard Drive CD-ROM drive Built-in sound system Available PCI slot

Temperature - Operating Temperature - Storage

50° to 131° F (10° to 55° C) -22° to 140° F (-30° to 60° C)

Relative Humidity -

20% to 80%

Operating

Operating Systems

Supported

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Technical Specifications - Controller Cards

HP IEEE 1394b FireWire

PCle Card

Data Transfer Rate Supports up to 800 Mbps

Devices Supported IEEE-1394 compliant devices **Bus Type** PCIe card full height PCIe slots

Ports Two IEEE-1394b bilingual 9-Pin Connector (Rear)

Internal Connectors One 10-Pin header Custom Connector

System Requirements Windows 7 Professional 32-bit and 64-bit, Microsoft® Windows® XP

> Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive CD-ROM

drive Built in sound system Available PCI slot

Temperature – Operating 50° to 131° F (10° to 55° C)

Temperature – Storage

-22° to 140° F (-30° to 60° C)

Relative Humidity –

Operating

20% to 80%

Compliances

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Windows 7 Professional 32-bit and 64-bit, Windows Vista® Business 32-bit

and 64-bit, Windows® XP Professional, XP Professional 64-bit. Not

supported on Linux.

HP USB 3.0 2x2 Port SuperSpeed PCle x1 Card Ports

Dimensions (HxD)

TBD

2 External, 2 internal

Operating Systems

Supported

Microsoft Windows 7, Windows Vista*, Windows XP Professional (32-bit and 64-bit); Red Hat Enterprise Linux 6.0, SuSE Linux Enterprise Desktop 11 Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Kit Contents I/O and Security Software and Documentation CD with software drivers and

> documentation, HP SuperSpeed USB 3.0 PCle x1 card (with full-height expansion bracket attached), SATA to SATA split power extension cable, Low profile expansion bracket to replace the full-height expansion bracket required on some computer models and HP SuperSpeed USB 3.0 PCle x1

Card Quick Setup.

registrations

Regulatory Approvals and FCC 15B, CE EN55022+ EN55024, VCCI, CISPR 22 AS/NZS CISPR 22,

LCIE CB service(ITE/AV) IEC 60950-1, Korea EMC, UL USB-IF

Weight 0.21 lb (95.0 g)

Warranty The HP USB 3.0 2x2 Port Super Speed PCle x1 Card has either a one-year

limited warranty or the remainder of the warranty of the HP product in which it is installed. Technical support is available seven days a week, 24 hours a day, by phone, as well as online support forums. Certain restrictions and

exclusions apply.



Technical Specifications - Controller Cards

HP SuperSpeed USB 3.0 Dimensions (HxD)

PCle x1 Card

Full-height: 4.13 x 2.32 in; Low profile: 2.68 x 2.32 in (Full-height: 104.89

x 59.04 mm; Low profile: 68.09 x 59.04 mm)

Ports 2 External

Operating Systems Supported

Microsoft Windows 7, Windows Vista*, Windows XP Professional (32-bit and 64-bit); Red Hat Enterprise Linux 6.0, SuSE Linux Enterprise Desktop 11

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Kit Contents I/O and Security Software and Documentation CD with software drivers and

> documentation, HP SuperSpeed USB 3.0 PCle x1 card (with full-height expansion bracket attached), SATA to SATA split power extension cable, Low profile expansion bracket to replace the full-height expansion bracket required on some computer models and HP SuperSpeed USB 3.0 PCle x1

Card Quick Setup.

registrations

Regulatory Approvals and FCC 15B, CE EN55022+ EN55024, VCCI, CISPR 22 AS/NZS CISPR 22,

LCIE CB service (ITE/AV) IEC 60950-1, Korea EMC, UL USB-IF

0.21 lb (95.0 g) Weight

Warranty The HP Super Speed USB 3.0 PCle x1 Card has either a one-year limited

warranty or the remainder of the warranty of the HP product in which it is installed. Technical support is available seven days a week, 24 hours a day,

by phone, as well as online support forums. Certain restrictions and

exclusions apply.



Technical Specifications - Networking and Communications

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Integrated Broadcom 5764 PCle LOM Controller Connector RJ45

Data Rates Supported 10/100/1000BT

Bus Architecture PCle X1
Alerting ASF 2.0

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash
Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity

Dimensions 7 cm x 10.5 cm (2.75 in x 4.13 in), low profile compatible

Operating System Driver Windows 7 Professional 32-bit and 64-bit, Windows Vista 32-bit SP1,

Support Windows Vista x64 SP1, Windows XP 32 bit professional, Windows XP x64

Red Hat Enterprise Linux(RHEL) WS4*, 5, 6 Desktop/Workstation

Novell SLED 10 & 11

*RHEL WS4 not supported on Z200/Z200SFF

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install

guide, product warranty statement



Technical Specifications - Networking and Communications

Intel Gigabit CT Desktop Connector

NIC

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

Dimensions 12.1 x 5.7 x 2.0 cm (4.75 x 2.25 x 0.8 in)

Operating System Driver

Support

Windows 7 Professional 32-bit and 64-bit, Windows Vista Business 64, Windows Vista Business 32, Windows XP Professional, Windows XP x64. Red Hat Enterprise Linux 4 (RHEL4.8 or newer)*, Red Hat Enterprise Linux 5

(RHEL5.3 or newer), Red Hat Enterprise Linux 6
* RHEL WS4 not supported on Z200/Z200SFF

Management Capabilities WOL, PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

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